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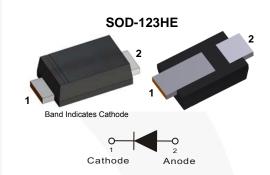


January 2016

RS1JFP - RS1MFP Surface Mount Fast Recovery Rectifiers

Features

- · Low Power Loss, High Efficiency
- · Larger Cathode Pad for Improved Power Dissipation
- Ultra Thin Profile Package Height <1.0 mm
- · High Surge Capacity
- · Low Forward Voltage: 1.3 V Maximum
- · UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- · RoHS Compliant / Green Molding Compound
- · Industrial Device Qualified per AEC-Q101 Standards
 - * See authorized use policy



Ordering Information

Part Number	Top Mark	Package	Packing Method
RS1JFP	JLS	SOD-123HE	Tape and Reel
RS1KFP	KLS	SOD-123HE	Tape and Reel
RS1MFP	MLS	SOD-123HE	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value			Unit
	Farameter	RS1JFP	RS1KFP	RS1MFP	Offic
V_{RRM}	Repetitive Peak Reverse Voltage	600	800	1000	V
V _{RMS}	RMS Reverse Voltage	420	560	700	V
V _R	DC Blocking Voltage	600	800	1000	V
I _{F(AV)}	Average Forward Rectified Current	1.2			Α
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	50		Α	
TJ	Operating Junction Temperature Range	-55 to +150		°C	
T _{STG}	Storage Temperature Range	-55 to +150		°C	

Thermal Characteristics(1)

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
ΨJL	Typical Thermal Characteristics, Junction-to-Lead ⁽²⁾	12	°C/W
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient	140	°C/W

Notes:

- 1. Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
- 2. Thermocouple soldered at cathode lead.

Electrical Characteristics

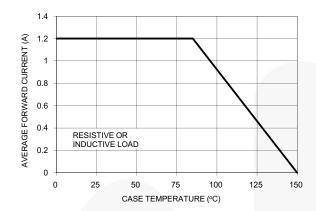
Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _F	Instantaneous Forward Voltage ⁽³⁾	I _F = 1.2 A			1.3	V
I _R	Reverse Current at Rated V _R	T _J = 25°C			5	μА
		T _J = 125°C			150	
CJ	Junction Capacitance	V _R = 0 V, f = 1 MHz		18		pF
T _{rr}	Reverse Recovery Time	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A			300	ns

Note:

3. Pulse test with PW = 300 μ s, 1% duty cycle

Typical Performance Characteristics



100

T_J=125°C

10

T_J=125°C

10

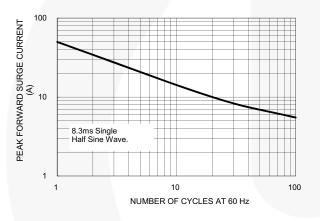
0.01

0 20 40 60 80 100 120 140

PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

Figure 1. Maximum Forward Current Derating Voltage

Figure 2. Typical Reverse Characteristics



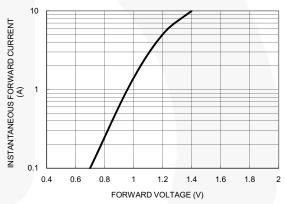
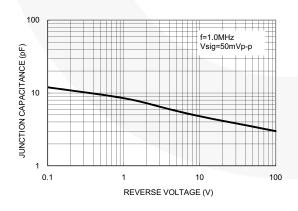


Figure 3. Maximum Non-Repetitive Forward Surge Current

Figure 4. Typical Instantaneous Forward Characteristics



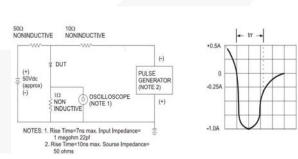
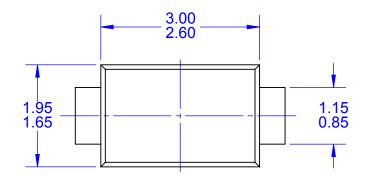
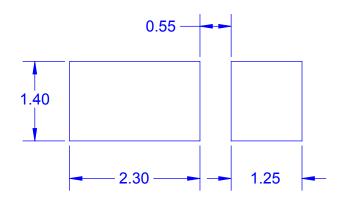
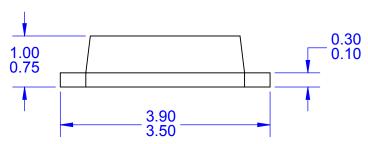


Figure 5. Typical Junction Capacitance

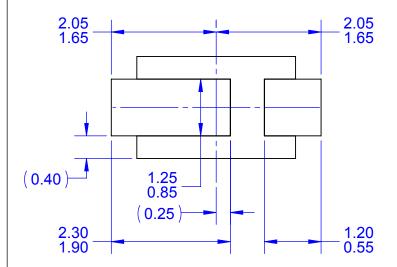
Figure 6. Reverse Recovery Time Characteristic and Test Circuit Diagram











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